

Bridgelux® V10 Array

Product Data Sheet DS42



V Series



Introduction

The V Series[™] LED Array products deliver high quality light in a compact and cost-effective solid-state lighting package. These Chip-on-Board (CoB) arrays can be efficiently driven at twice the nominal drive current, enabling design flexibility not previously possible. This high flux density light source is designed to support a wide range of high quality, low cost directional luminaires and replacement lamps for commercial and residential applications.

The V10 LED Array is available in a variety of electrical, CCT and CRI combinations providing substantial design flexibility and energy efficiencies.

Lighting system designs incorporating these LED Arrays deliver comparable performance to 26 Watt compact fluorescent and 150 Watt incandescent and halogen based luminaires, delivering increased system level efficacy and longer service life. Typical applications include, but are not limited to, replacement lamps, task, accent, spot, track, down light, wide area, security, and wall pack.

Features

- Market leading efficacy of 130 lm/W typical
- Compact high flux density light source
- Uniform high quality illumination
- Minimum 70, 80 and 90 CRI options
- Streamlined thermal path
- Energy Star / ANSI compliant color binning structure with 3SDCM and 4SDCM options
- More energy efficient than incandescent, halogen
 and fluorescent lamps
- Low voltage DC operation
- Instant light with unlimited dimming

Benefits

- Enhanced optical control
- Clean white light without pixilation
- High quality true color reproduction
- Significantly reduced thermal resistance and increased operating temperatures
- · Uniform consistent white light
- Lower operating costs
- Easy to use with daylight and motion detectors to enable increased energy savings
- Reduced maintenance costs
- Environmentally friendly, no disposal issue

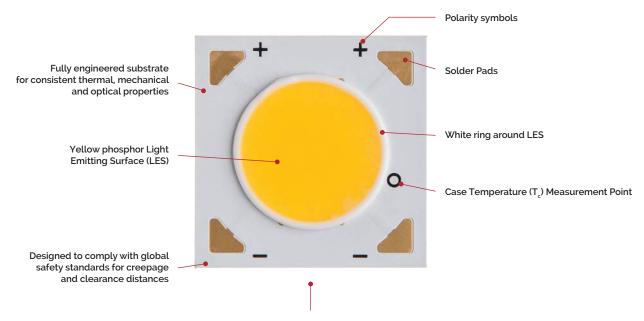


Contents

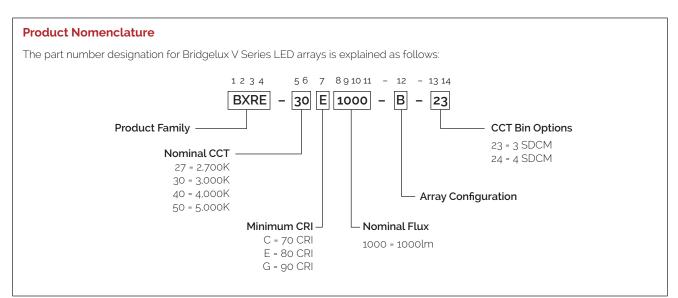
Product Feature Map	2
Product Nomenclature	2
Product Selection Guide	3
Performance at Commonly Used Drive Currents	4
Flux & Electrical Characteristics	6
Absolute Maximum Ratings	7
Performance Curves	8
Typical Radiation Pattern	12
Typical Color Spectrum	13
Mechanical Dimensions	14
Color Binning Information	15
Packaging	16
Design Resources	18
Precautions	18
Disclaimers	18
About Bridgelux	19

Product Feature Map

Bridgelux arrays are fully engineered devices that provide consistent thermal and optical performance on an engineered mechanical platform. The V Series arrays are the most compact chip-on-board devices across all of Bridgelux's LED Array products. The arrays incorporate several features to simplify design integration and assembly.



Note: Part number and lot codes are scribed on back of array



Product Selection Guide

The following product configurations are available:

Table 1: Selection Gui	de, Pulsed Measuremen	t Data (T _i = T _c = 25°C)
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Part Number	Nominal CCT ¹ (K)	CRI²	Nominal Drive Current³ (mA)	Typical Pulsed Flux ^{4.5.6} T _c = 25°C (lm)	Minimum Pulsed Flux ^{6,7} T _c = 25°C (lm)	Typical V _f (V)	Typical Power (W)	Typical Efficacy (lm/W)
BXRE-27E1000-B-2x	2700	80	350	1150	1047	26.5	9.3	124
BXRE-27G1000-B-2x	2700	90	350	890	825	26.5	9.3	96
BXRE-30E1000-B-2x	3000	80	350	1200	1080	26.5	9.3	129
BXRE-30G1000-B-2x	3000	90	350	950	866	26.5	9.3	102
BXRE-40E1000-B-2x	4000	80	350	1280	1158	26.5	9.3	138
BXRE-40G1000-B-2x	4000	90	350	1070	989	26.5	9.3	115
BXRE-50C1000-B-24	5000	70	350	1330	1230	26.5	9.3	143
BXRE-50E1000-B-24	5000	80	350	1257	1173	26.5	9.3	136
BXRE-50G1000-B-24	5000	90	350	1106	1010	26.5	9.3	119

Table 2: Selection Guide, Stabilized DC Performance (T_c = 85°C) ^{8.9}

Part Number	Nominal CCT ¹ (K)	CRI²	Nominal Drive Current³ (mA)	Typical DC Flux T _c = 85°C (lm)	Minimum DC Flux ¹⁰ T _c = 85°C (lm)	Typical V _f (V)	Typical Power (W)	Typical Efficacy (lm/W)
BXRE-27E1000-B-2x	2700	80	350	1022	931	25.7	9.0	114
BXRE-27G1000-B-2x	2700	90	350	791	733	25.7	9.0	88
BXRE-30E1000-B-2x	3000	80	350	1075	967	25.7	9.0	120
BXRE-30G1000-B-2x	3000	90	350	851	776	25.7	9.0	95
BXRE-40E1000-B-2x	4000	80	350	1147	1038	25.7	9.0	128
BXRE-40G1000-B-2x	4000	90	350	959	886	25.7	9.0	107
BXRE-50C1000-B-24	5000	70	350	1154	1067	25.7	9.0	128
BXRE-50E1000-B-24	5000	80	350	1090	1017	25.7	9.0	121
BXRE-50G1000-B-24	5000	90	350	959	876	25.7	9.0	107

Notes for Tables 1 & 2:

- 1. Nominal CCT as defined by ANSI C78.377-2011.
- 2. CRI Values are minimums. Minimum Rg value for 80 CRI products is 0, the minimum Rg values for go CRI products is 50.
- 3. Drive current is referred to as nominal drive current.
- 4. Products tested under pulsed condition (10ms pulse width) at nominal test current where T_i (junction temperature) = T_c (case temperature) = 25°C.
- 5. Typical performance values are provided as a reference only and are not a guarantee of performance.
- 6. Bridgelux maintains a ±7% tolerance on flux measurements.
- 7. Minimum flux values at nominal test current are guaranteed by 100% test.
- 8. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance
- 9. Typical performance is estimated based on operation under DC (direct current) with LED array mounted onto a heat sink with thermal interface material and the case temperature maintained at 85°C. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and/or the exposed environment to which the product is subjected.
- 10. Minimum flux values at elevated temperatures are provided for reference only and are not guaranteed by 100% production testing. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and/or the exposed environment to which the product is subjected.

Performance at Commonly Used Drive Currents

V Series LED arrays are tested to the specifications shown using the nominal drive currents in Table 1. V Series may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _c = 25°C (V)	Typical Power T _c = 25°C (W)	Typical Flux² T _c = 25°C (lm)	Typical DC Flux³ T _c = 85°C (lm)	Typical Efficacy Tຼ = 25°C (lm/W)
		175	24.9	4.4	606	538	139
BXRE-27E1000-B-2x	80	350	26.5	9.3	1150	1022	124
DARE-27E1000-B-2X	00	500	27.6	13.8	1577	1402	114
		700	29.0	20.3	2075	1844	102
		175	24.9	4.4	469	417	108
		350	26.5	9.3	890	791	96
BXRE-27G1000-B-2x	90	500	27.6	13.8	1220	1085	88
		700	29.0	20.3	1606	1427	79
		175	24.9	4.4	632	566	145
	80	350	26.5	9.3	1200	1075	129
BXRE-30E1000-B-2x	00	500	27.6	13.8	1646	1474	119
		700	29.0	20.3	2165	1939	107
-		175	24.9	4.4	500	448	115
		350	26.5	9.3	950	851	102
BXRE-30G1000-B-2x	90	500	27.6	13.8	1303	1167	94
		700	29.0	20.3	1714	1535	84
		175	24.9	4.4	674	604	155
	80	350	26.5	9.3	1280	1147	138
BXRE-40E1000-B-2x	00	500	27.6	13.8	1755	1573	127
		700	29.0	20.3	2310	2070	114

Table 3: Product Performance at	Commonly Used Drive Currents
Table J. Freduct Ferrermance at	Some of the set of the

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a ± 7% tolerance on flux measurements.

3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _c = 25°C (V)	Typical Power T _c = 25°C (W)	Typical Flux² T _c = 25°C (lm)	Typical DC Flux³ T _c = 85°C (lm)	Typical Efficacy Tू = 25°C (lm/W)	
		175	24.9	4.4	564	505	129	
BXRE-40G1000-B-2x	90	350	26.5	9.3	1070	959	115	
DARE-40G1000-B-2X	90	500	27.6	13.8	1467	1315	106	
		700	29.0	20.3	1931	1730	95	
		175	24.9	4.4	701	608	161	
BXRE-50C1000-B-24	70	350	26.5	9.3	1330	1154	143	
BARE-50C1000-B-24	/0	500	27.6	13.8	1824	1582	132	
			700	29.0	20.3	2400	2082	118
		175	24.9	4.4	662	574	152	
BXRE-50E1000-B-24	80	350	26.5	9.3	1257	1090	136	
DARE-50E1000-D-24	80	500	27.6	13.8	1724	1495	125	
		700	29.0	20.3	2268	1967	112	
		175	24.9	4.4	583	505	134	
BXRE-50G1000-B-24		350	26.5	9.3	1106	959	119	
DARE-5001000-B-24	90	500	27.6	13.8	1517	1315	110	
		700	29.0	20.3	1996	1731	98	

Table 3: Product Performance at Commonly Used Drive Currents (Continued)

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a ± 7% tolerance on flux measurements.

3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Electrical Characteristics

Table 4: Electrical Characteristics

			Forward Voltage Pulsed, T _c = 25°C (V) ^{1,2,3}			Typical Thermal		election ages ⁷ /)
Part Number	Drive Current (mA)	Minimum	Typical	Maximum	of Forward Voltage⁴ ∆V _r ∕∆T _c (mV∕°C)	Resistance Junction to Case ^{5.6} R _{j-c} (°C/W)	V _r Min. Hot T _c = 105°C (V)	V _F Max. Cold T _c = -40°C (V)
	350	24.5	26.5	28.5	-14	0.47	23.4	29.4
BXRE-xxx1000-B-2x	700	26.5	29.0	31.2	-14	0.59	25.4	32.1

Notes for Table 4:

1. Parts are tested in pulsed conditions, $T_c = 25^{\circ}$ C. Pulse width is 10ms.

2. Voltage minimum and maximum are provided for reference only and are not a guarantee of performance.

3. Bridgelux maintains a tester tolerance of ± 0.10V on forward voltage measurements.

4. Typical coefficient of forward voltage tolerance is ± 0.1mV for nominal current.

5. Thermal resistance values are based from test data of a 3000K 80 CRI product.

6. Thermal resistance value was calculated using total electrical input power; optical power was not subtracted from input power. The thermal interface material used during testing is not included in the thermal resistance value.

7. V_r min hot and max cold values are provided as reference only and are not guaranteed by test. These values are provided to aid in driver design and selection over the operating range of the product.

Absolute Maximum Ratings

Table 5: Maximum Ratings

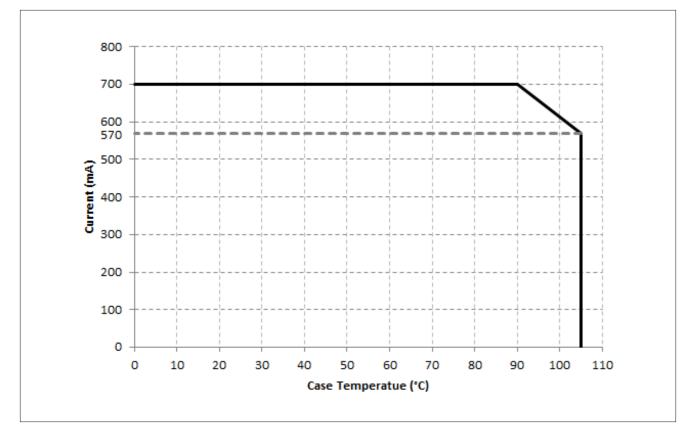
Parameter	Maximum Rating
LED Junction Temperature (Tj)	150°C
Storage Temperature	-40°C to +105°C
Operating Case Temperature ¹ (T _c)	105°C
Soldering Temperature ²	350°C or lower for a maximum of 10 seconds
Maximum Drive Current ³	700mA
Maximum Peak Pulsed Drive Current4	1000mA
Maximum Reverse Voltage ⁵	-45V

Notes for Table 5:

- 1. Please refer to Figure 1 for drive current derating. For IEC 62717 requirement, please contact Bridgelux Sales Support.
- 2. See Bridgelux Application Note AN41, Assembly Considerations for V Series LED arrays, for more information.
- 3. Please refer to Figure 1 for drive current derating curve.
- 4. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 20ms when operating LED Arrays at the maximum peak pulsed current specified. Maximum peak pulsed currents indicate values where the LED array can be driven without catastrophic failures.
- 5. Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition. Maximum rating provided for reference only.

The maximum allowable drive current for the V10 product family is dependent on the operating case temperature. Please refer to the Product Feature Map (page 2) for the location of the T_ Point.





Notes for Figure 1:

In order to meet LM-80 lifetime projections V10 may be driven up to 700mA at case temperatures up to 90°C. Operating conditions above case temperatures of 90°C driving conditions must follow the V10 Drive Current Derating Curve.

2. Lumen maintenance (L70) and lifetime predictions are valid for drive current and case temperature conditions used for LM-80 testing as included in the applicable LM-80 test report for these products. Contact your Bridgelux sales representative for LM-80 report.

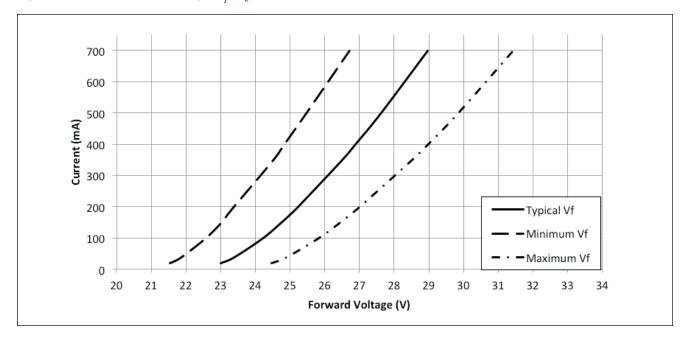
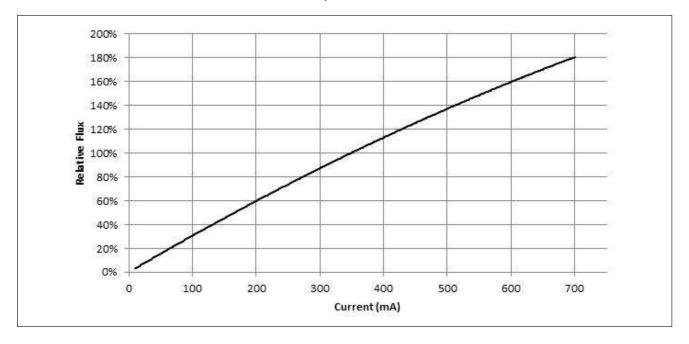


Figure 2: Drive Current vs. Voltage ($T_i = T_c = 25^{\circ}C$)





Note for Figure 3:

 Bridgelux does not recommend driving high power LEDs at low currents. Doing so may produce unpredictable results. Pulse width modulation (PWM) is recommended for dimming effects.

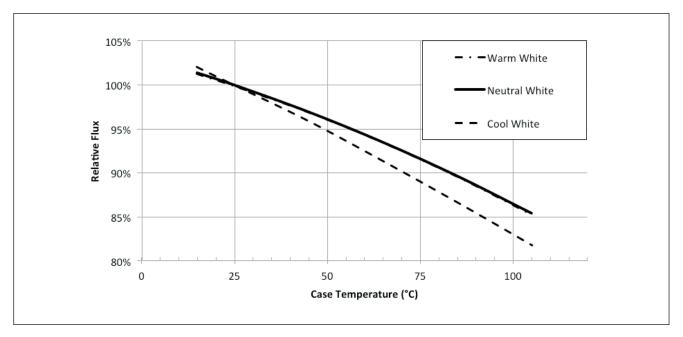
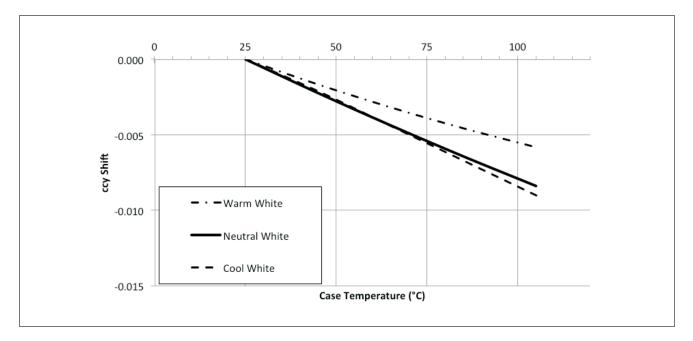


Figure 4: Typical DC Flux vs. Case Temperature

Figure 5: Typical DC ccy Shift vs. Case Temperature



Notes for Figures 4-5:

- 1. Characteristics shown for warm white based on 3000K and 80 CRI.
- 2. Characteristics shown for neutral white based on 4000K and 80 CRI.
- 3. Characteristics shown for cool white based on 5000K and 70 CRI.
- 4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

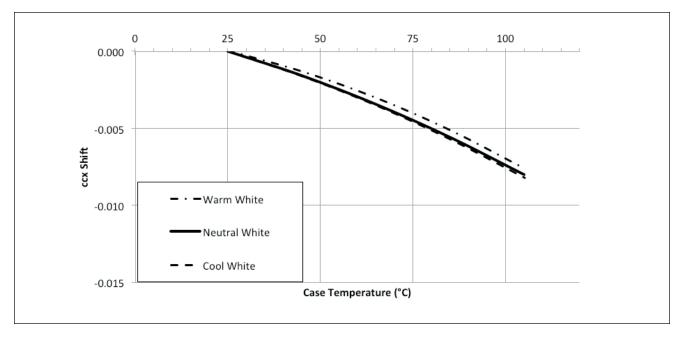


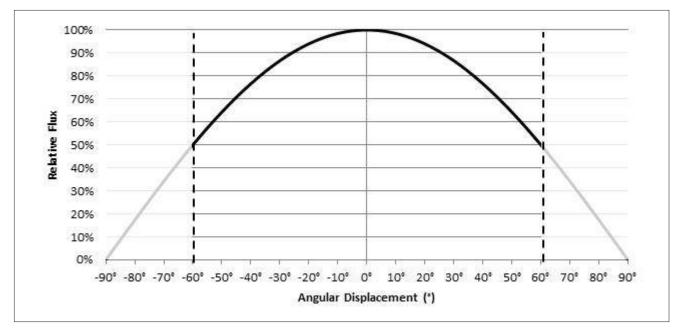
Figure 6: Typical DC ccx Shift vs. Case Temperature

Notes for Figure 6:

- 1. Characteristics shown for warm white based on 3000K and 80 CRI.
- 2. Characteristics shown for neutral white based on 4000K and 80 CRI.
- 3. Characteristics shown for cool white based on 5000K and 70 CRI.
- 4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Typical Radiation Pattern

Figure 7: Typical Spatial Radiation Pattern

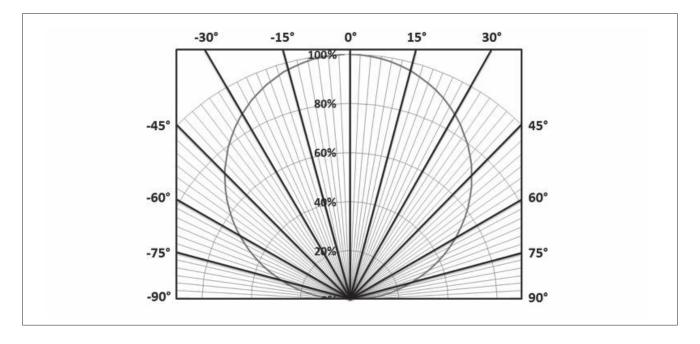


Note for Figure 7:

1. Typical viewing angle is 120°.

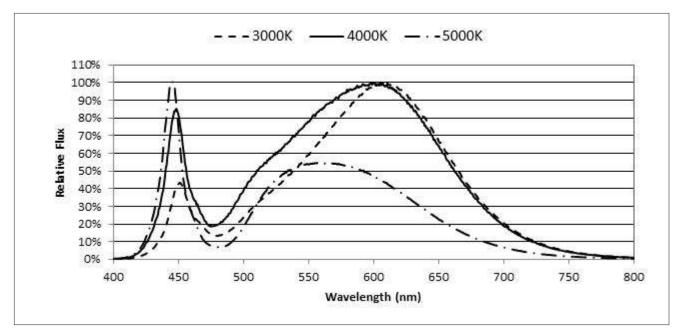
2. The viewing angle is defined as the off axis angle from the centerline where Iv is ½ of the peak value.

Figure 8: Typical Polar Radiation Pattern



Typical Color Spectrum

Figure 9: Typical Color Spectrum

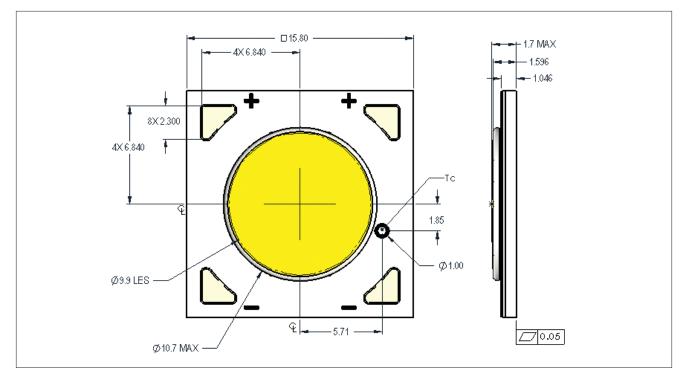


Note for Figure 9:

- 1. Color spectra measured at nominal current for $T_j = T_c = 25^{\circ}C$.
- 2. Color spectra shown for warm white is 3000K and 80 CRI.
- 3. Color spectra shown for neutral white is 4000K and 80 CRI.
- 4. Color spectra shown for cool white is 5000K and 70 CRI.

Mechanical Dimensions

Figure 10: Drawing for V10 LED Array



Notes for Figure 10:

- 1. Solder pads are labeled "+" and "-" to denote positive and negative polarity, respectively.
- 2. It is not necessary to provide electrical connections to both sets of solder pads. Either set may be used depending on application specific design requirements.
- 3. Drawings are not to scale.
- 4. Drawing dimensions are in millimeters.
- 5. Unless otherwise specified, tolerances are ± 0.10mm.
- 6. The optical center of the LED Array is nominally defined by the mechanical center of the array. The light emitting surface (LES) is centered on the mechanical center of the array to a tolerance of ± 0.45 mm
- 7. Bridgelux maintains a flatness of 0.1 mm across the mounting surface of the array. Refer to Application Notes AN40 and AN41 for product handling, mounting and heat sink recommendations.

Color Binning Information

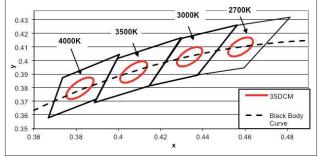
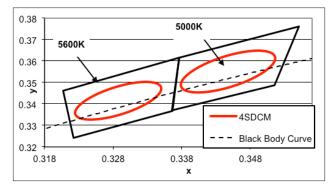


Figure 11: Graph of Warm and Neutral White Test Bins in xy Color Space

Table 6: Warm and Neutral White xy Bin Coordinates and Associated Typical CCT

Bin Code	2700K	3000K	3500K	4000K
ANSI Bin (for reference only)	(2580K - 2870K)	(2870K - 3220K)	(3220K - 3710K)	(3710K - 4260K)
03 (3SDCM)	(2651K - 2794K)	(2968K - 3136K)	(3369K - 3586K)	(3851K - 4130K)
02 (2SDCM)	(2674K - 2769K)	(2995K - 3107K)	(3404K - 3548K)	(3895K - 4081K)
Center Point (x,y)	(0.4578, 0.4101)	(0.4338, 0.403)	(0.4073, 0.3917)	(0.3818, 0.3797)

Figure 12: Graph of Cool White Test Bins in xy Color Space



Note: Pulsed Test Conditions, $T_c = 25^{\circ}C$

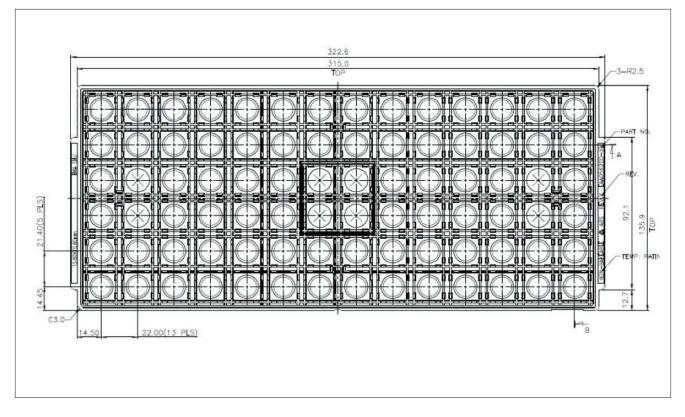
Table 7: Cool White xy Bin Coordinates and Associated Typical CCT

Bin Code	5000K	5600K
ANSI Bin (for reference only)	(4745K - 5311K)	(5310K - 6020K)
04 (4SDCM)	(4801K - 5282K)	(5475K - 5830K)
Center Point (x,y)	(0.3447, 0.3553)	(0.3293, 0.3423)

Note: Pulsed Test Conditions, $T_c = 25^{\circ}C$

Packaging

Figure 13: Drawing for V10 Packaging Tray



Notes for Figure 13:

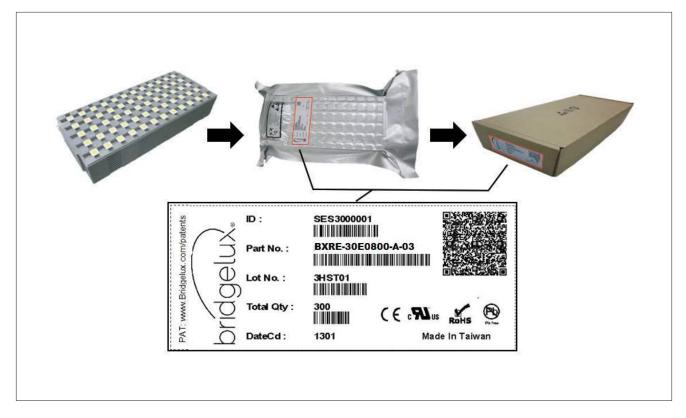
1. Dimensions are in millimeters

2. Tolerances: X.X = ± 0.25, X.XX = ± 0.13, X°0' = ±0°30'

3. Trays are stackable without interference and will not stick together during unstacking operation

Packaging

Figure 14: V Series Packaging and Labeling



Notes for Figure 14:

- 1. Each tray holds 84 LEDs, 10 trays are stacked and one empty tray placed on top to cover the top tray.
- 2. Stacked trays are to contain only 1 part number and be vacuum sealed in an anti-static bag and placed in its own individual box.
- 3. Each bag and box is to be labeled as shown above.

Design Resources

Application Notes

Bridgelux has developed a comprehensive set of application notes and design resources to assist customers in successfully designing with the V Series product family of LED array products. For a list of of resources under development, visit www.bridgelux.com.

Optical Source Models

Optical source models and ray set files are available for all Bridgelux products. For a list of available formats, visit www.bridgelux.com.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED array. Please consult Bridgelux Application Note AN41 for additional information.

CAUTION: EYE SAFETY

Eye safety classification for the use of Bridgelux V Series LED arrays is in accordance with IEC specification EN62471: Photobiological Safety of Lamps and Lamp Systems. V Series LED arrays are classified as Risk Group 1 (Low Risk) when operated at or below the maximum drive current. Please use appropriate precautions. It is important that employees working with LEDs are trained to use them safely.

CAUTION: RISK OF BURN

Do not touch the V Series LED array or yellow resin area during operation. Allow the array to cool for a sufficient period of time before handling. The V Series LED array may reach elevated temperatures such that could burn skin when touched.

Disclaimers

3D CAD Models

Three dimensional CAD models depicting the product outline of all Bridgelux V Series LED arrays are available in both SAT and STEP formats. Please contact your Bridgelux sales representative for assistance.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the LED array or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the LED array.

Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area). Optical devices may be mounted on the top surface of the plastic housing of the V Series LED array. Use the mechanical features of the LED array housing, edges and/or mounting holes to locate and secure optical devices as needed.

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

STANDARD TEST CONDITIONS

Unless otherwise stated, array testing is performed at the nominal drive current.

About Bridgelux

Bridgelux is a leading developer and manufacturer of technologies and solutions transforming the \$40 billion global lighting industry into a \$100 billion market opportunity. Based in Livermore, California, Bridgelux is a pioneer in solid state lighting (SSL), expanding the market for light emitting diode (LED) technologies by driving down the cost of LED lighting systems. Bridgelux's patented light source technology replaces traditional technologies (such as incandescent, halogen, fluorescent and high intensity discharge lighting) with integrated, solid state lighting solutions that enable lamp and luminaire manufacturers to provide high performance and energy efficient white light for the rapidly growing interior and exterior lighting markets, including street lights, commercial lighting and consumer applications.

For more information about the company, please visit bridgelux.com.



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